

N-Channel Enhancement Mode Field Effect Transistor

Product Summary

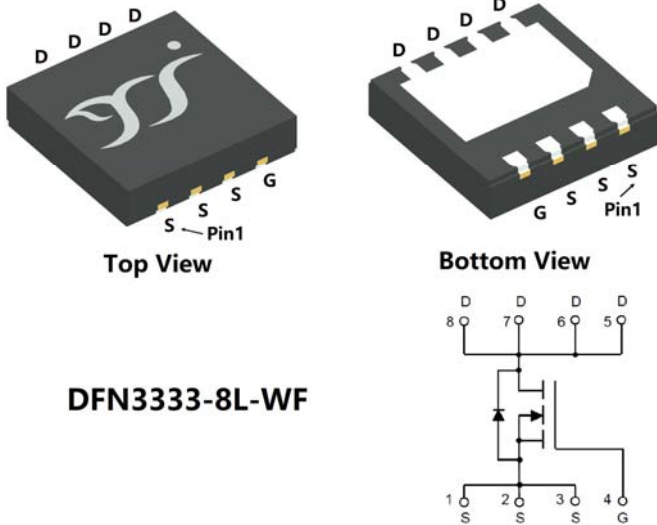
- V_{DS} 60V
- I_D 70A
- $R_{DS(ON)}$ (at $V_{GS}=10V$) $<5.5m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $<9m\Omega$
- 100% EAS Tested

General Description

- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free
- Part no. with suffix "Q" means AEC-Q101 qualified

Applications

- Power switching application
- Uninterruptible power supply
- DC-DC convertor
- 12V and 24V Automotive systems



DFN3333-8L-WF

■ Absolute Maximum Ratings ($T_J=25^\circ C$ unless otherwise noted)

Parameter		Symbol	Limit	Unit		
Drain-source Voltage		V_{DS}	60	V		
Gate-source Voltage		V_{GS}	± 20	V		
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25^\circ C, V_{GS}=10V$	12.7	A		
		$T_A=100^\circ C, V_{GS}=10V$	9			
Continuous Drain Current (Note 1,3)	Steady-State	$T_C=25^\circ C, V_{GS}=10V$	70			
		$T_C=100^\circ C, V_{GS}=10V$	49			
Pulsed Drain Current	$T_C=25^\circ C, t_p=100\mu s$		I_{DM}	280	A	
Avalanche energy		$V_G=10V, R_G=25\Omega, L=1mH, I_{AS}=15A$		EAS	112.5	mJ
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^\circ C$	P_D	2.5	W	
		$T_A=100^\circ C$		1.25		
Continuous Drain Current (Note 1,3)	Steady-State	$T_C=25^\circ C$		75		
		$T_C=100^\circ C$		37		
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+175	$^\circ C$		

■ Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	Steady-State	$R_{\theta JA}$	50	60	$^\circ C/W$
Thermal Resistance Junction-to-Case	Steady-State	$R_{\theta JC}$	1.6	2	

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ5D5G06AQ	F1	Q5D5G06A	5000	10000	100000	13" reel



YJQ5D5G06AQ

■ Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	60	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V, V _{GS} =0V	-	-	1	μA
		V _{DS} =60V, V _{GS} =0V, T _J =125°C	-	-	100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	1.0	1.6	2.5	V
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	4.5	5.5	mΩ
		V _{GS} =4.5V, I _D =20A	-	6.2	9	
Diode Forward Voltage	V _{SD}	I _S =20A, V _{GS} =0V	-	-	1.2	V
Gate resistance	R _G	f=1MHz	-	2	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	70	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =30V, V _{GS} =0V, f=1MHz	-	1730	-	pF
Output Capacitance	C _{oss}		-	500	-	
Reverse Transfer Capacitance	C _{rss}		-	20	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V, V _{DS} =30V, I _D =35A	-	33	-	nC
Gate-Source Charge	Q _{gs}		-	8	-	
Gate-Drain Charge	Q _{gd}		-	9	-	
Reverse Recovery Charge	Q _{rr}	I _F =35A, di/dt=100A/us	-	41	-	nC
Reverse Recovery Time	t _{rr}		-	37	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DD} =30V, I _D =35A R _{GEN} =3Ω	-	15	-	ns
Turn-on Rise Time	t _r		-	54	-	
Turn-off Delay Time	t _{D(off)}		-	30	-	
Turn-off fall Time	t _f		-	24	-	

Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of R_{θJA} is measured with the device mounted on the 40mm*40mm*1.1mm single layer FR-4 PCB board with 1 in² pad of 2oz. Copper, in the still air environment with T_A =25°C. The maximum allowed junction temperature of 175°C. The value in any given application depends on the user's specific board design.
- Thermal resistance from junction to soldering point (on the exposed drain pad).



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Typical Electrical and Thermal Characteristics Diagrams

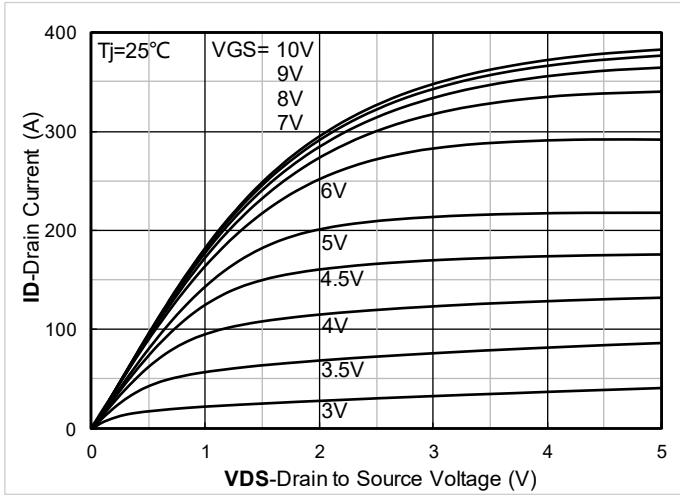


Figure 1. Output Characteristics

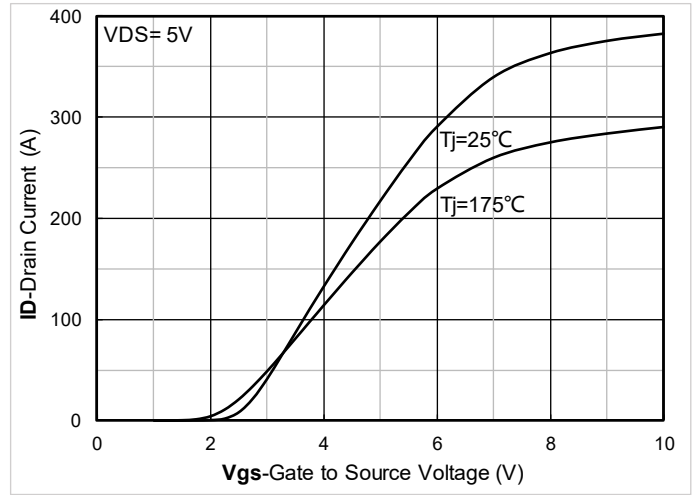


Figure 2. Transfer Characteristics

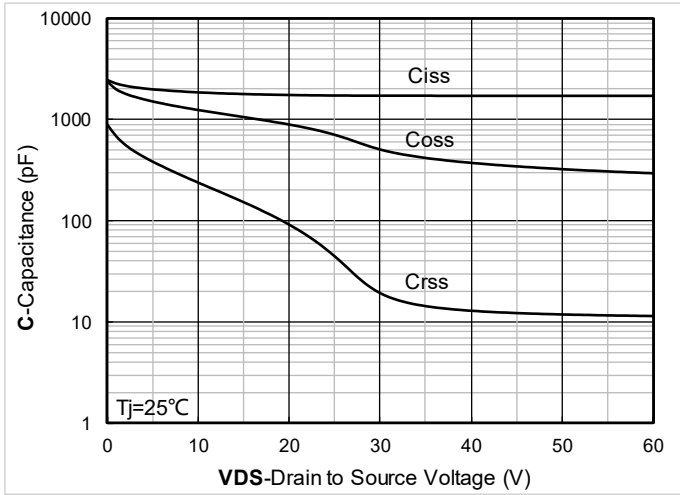


Figure 3. Capacitance Characteristics

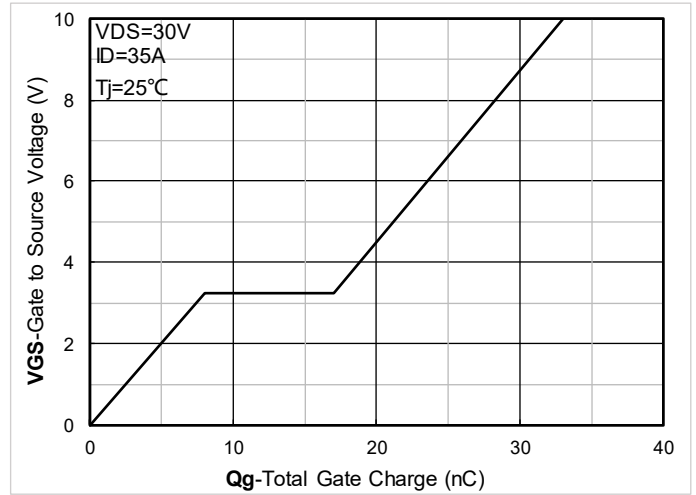


Figure 4. Gate Charge

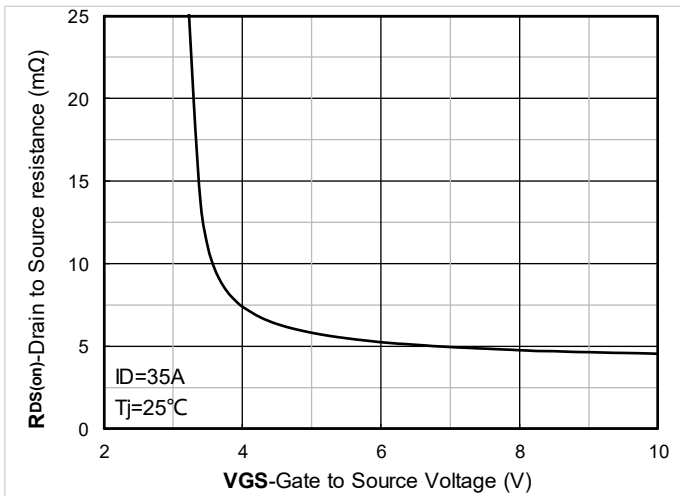


Figure 5. On-Resistance vs Gate to Source Voltage

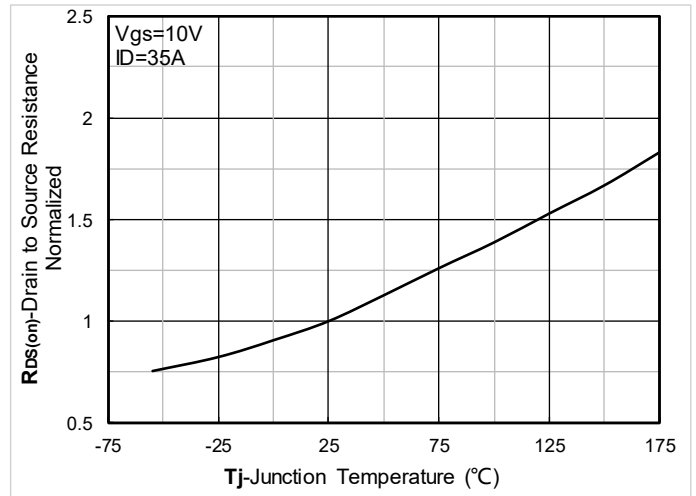


Figure 6. Normalized On-Resistance



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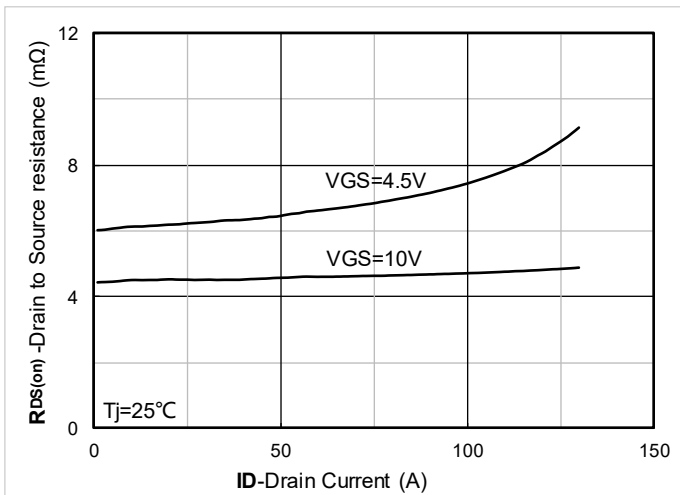


Figure 7. $R_{DS(on)}$ VS Drain Current

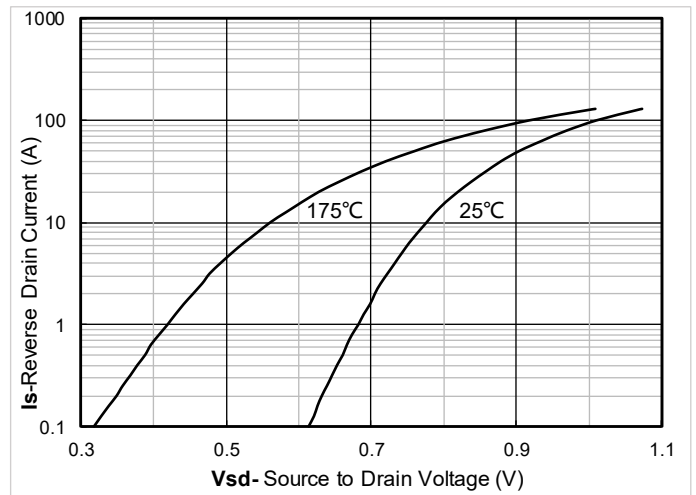


Figure 8. Forward characteristics of reverse diode

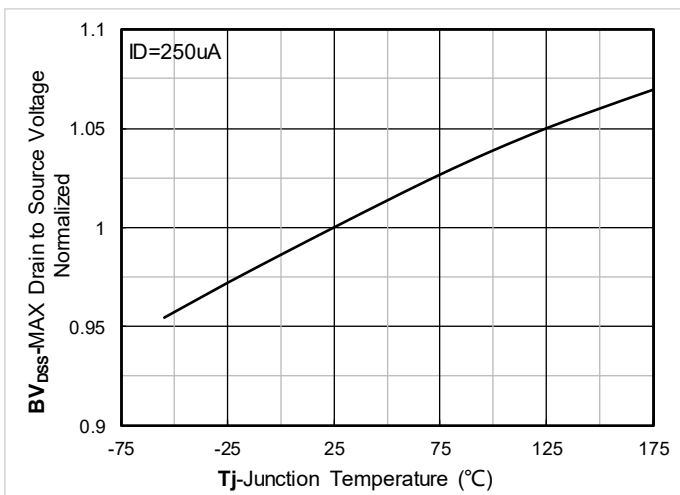


Figure 9. Normalized breakdown voltage

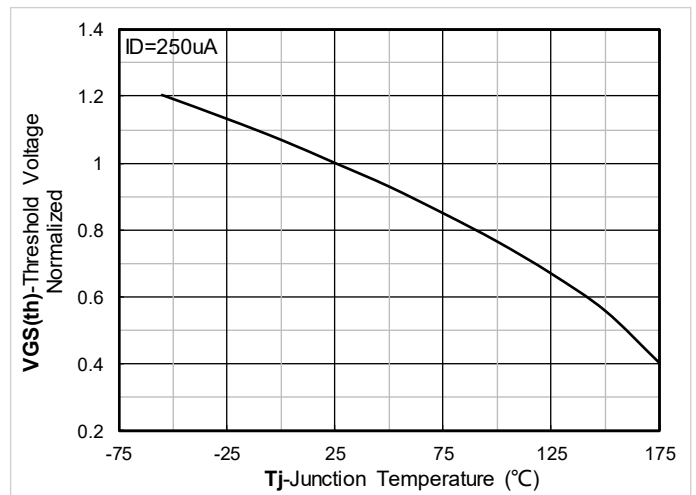


Figure 10. Normalized Threshold voltage

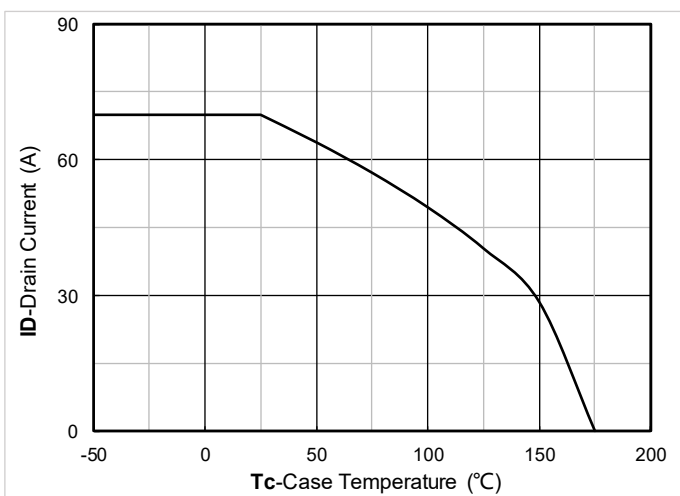


Figure 11. Current dissipation

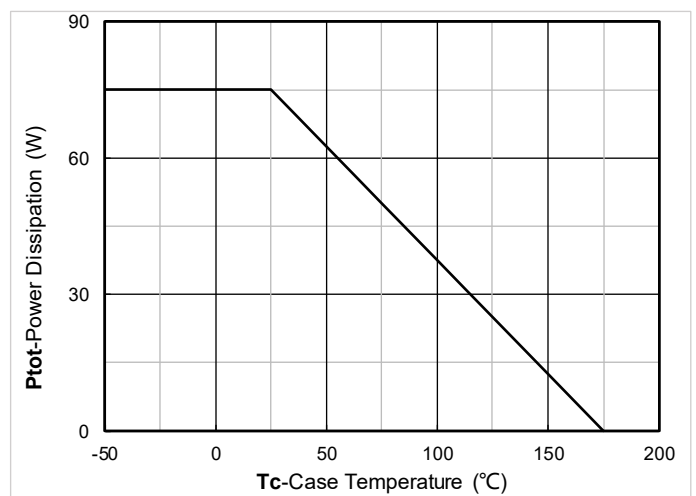


Figure 12. Power dissipation



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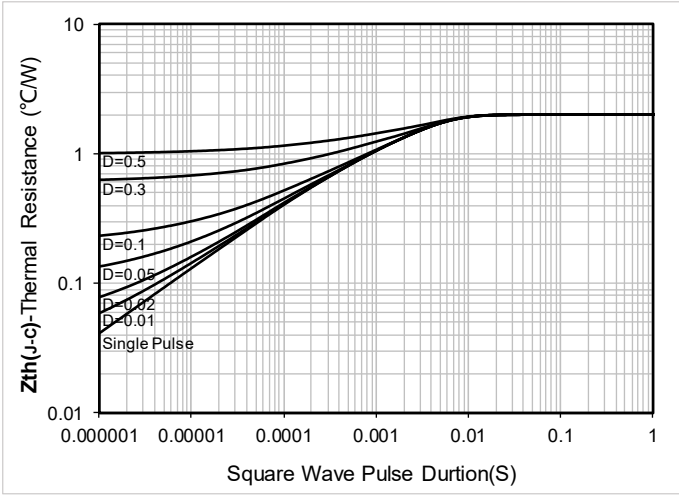


Figure 13. Maximum Transient Thermal Impedance

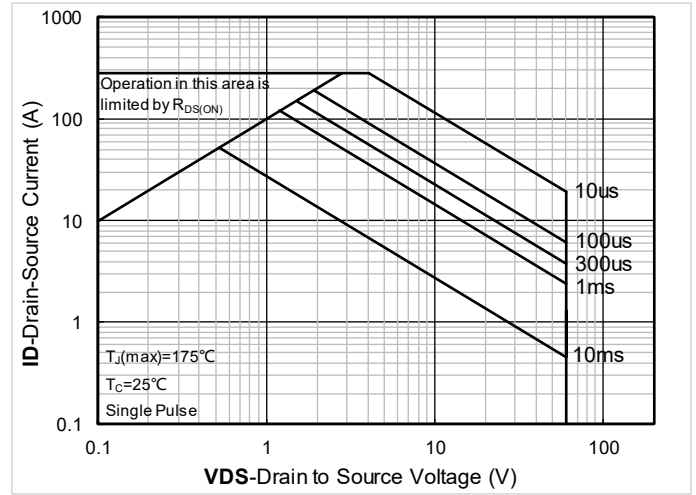


Figure 14. Safe Operation Area

■ Test Circuits & Waveforms

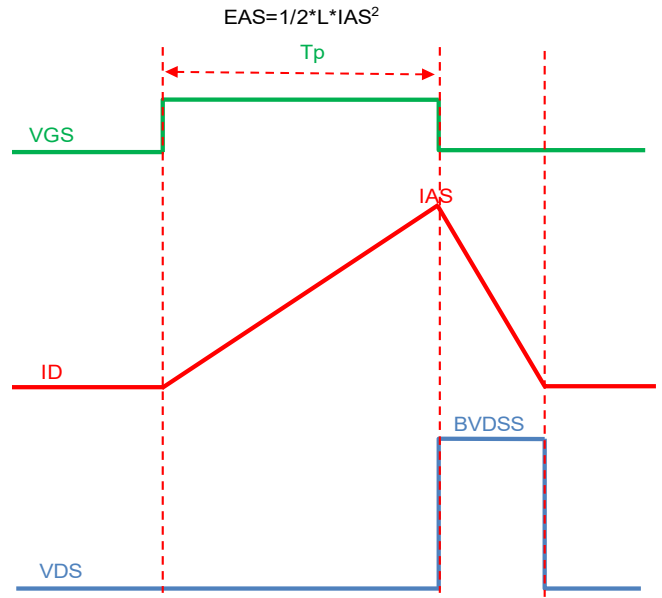
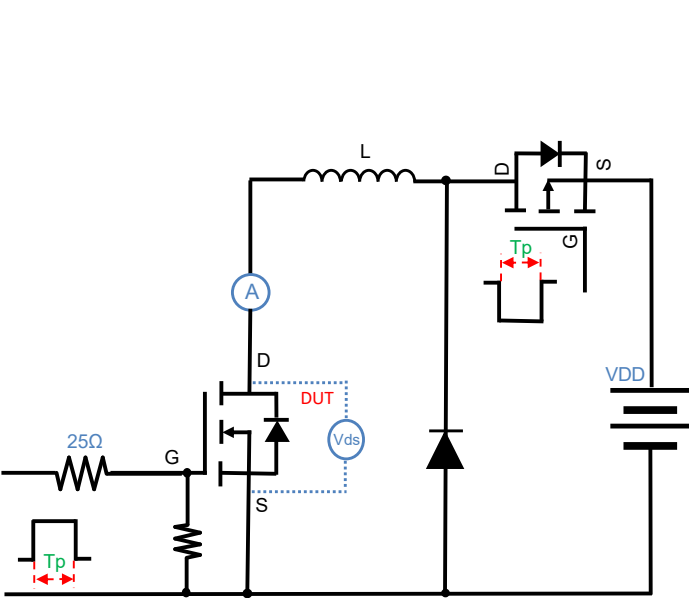


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

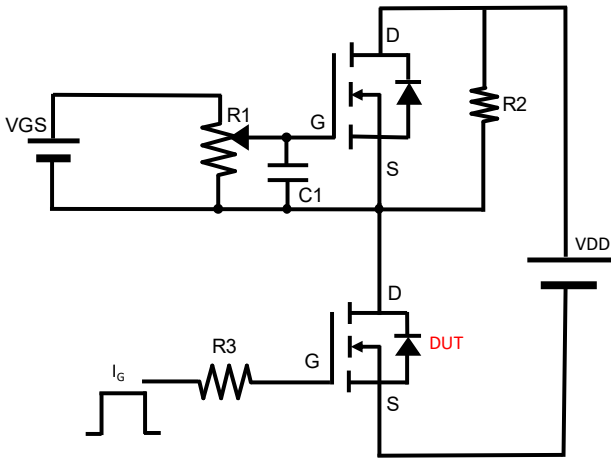


Figure B. Gate Charge Test Circuit & Waveform

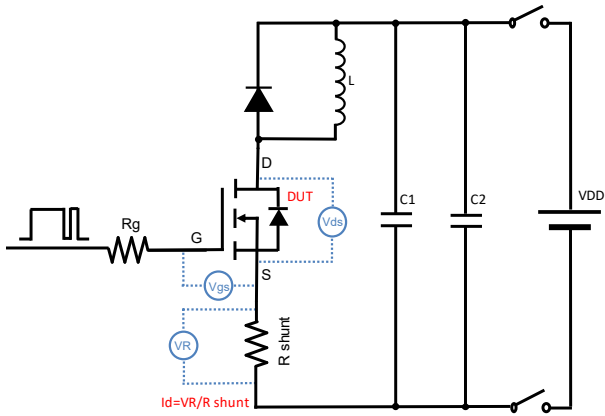


Figure C. Resistive Switching Test Circuit & Waveform

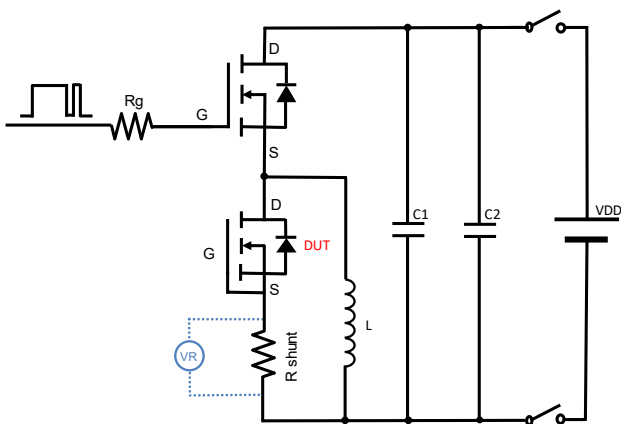
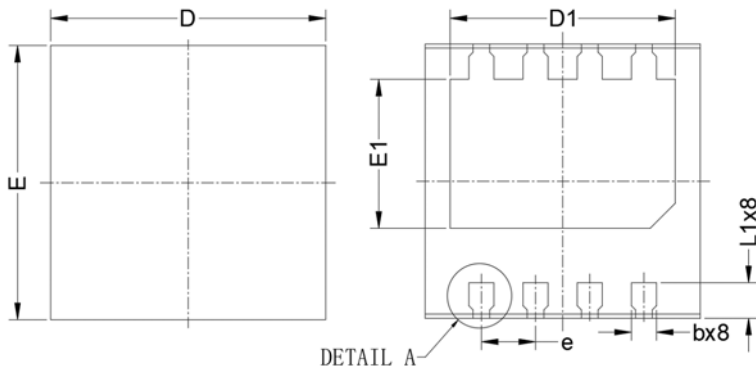


Figure D. Diode Recovery Test Circuit & Waveform



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DFN3333-8L-WF Package information



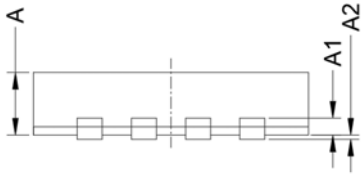
Top View
正面视图

Bottom View
背面视图

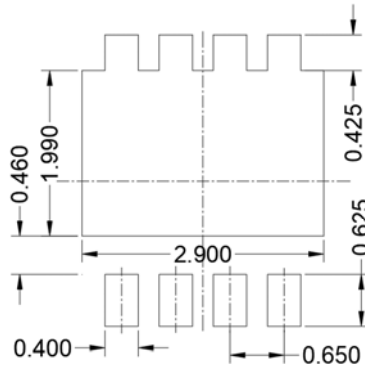
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.30 BSC		
E	3.30 BSC		
A	0.70	0.75	0.80
A1	0.203 BSC		
A2			0.10
D1	2.60	2.70	2.80
E1	1.69	1.79	1.89
L1	0.325	0.425	0.525
b	0.20	0.30	0.40
e	0.65 BSC		

Note:

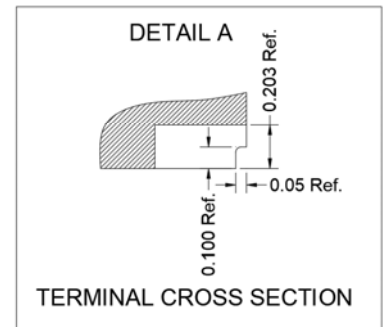
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.10\text{mm}$.
3. The pad layout is for reference purposes only.



Side View
侧面视图



Suggested Solder Pad Layout
Top View





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